

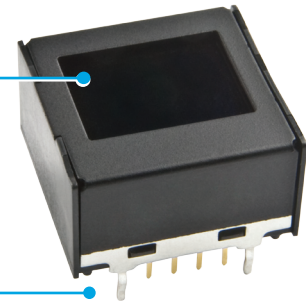
DISTINCTIVE CHARACTERISTICS

- Organic LED technology
- Range of 65,536 colors in 16 bit mode, 256 colors in 8 bit mode
- Full viewing angle of 180°
- Exceptional contrast: 50 times greater than previous LCD products, four times more enhanced resolution
- High resolution provides sharp, clear images of very small characters
- Operated by commands and data supplied via serial communications (SPI)
- Dust tight construction
- Stylish, translucent black housing design

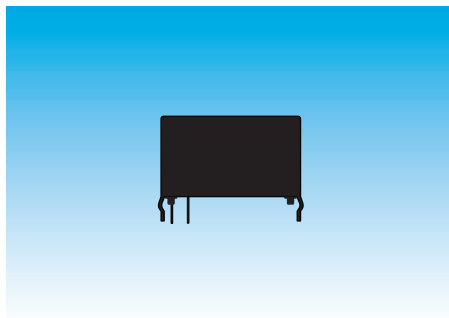
Viewing area: 12.9mm x 9.9mm (horizontal x vertical)

High resolution of 52RGB x 36 pixels

Bracket has crimped legs to ensure secure PC mounting and prevent dislodging during wave soldering



Actual Size



DISPLAY DESCRIPTION



Display Description	OLED	Pixel Format
Straight PC Terminals	Color OLED Display Module 65,536 Colors	52RGB x 36 Pixels Horizontal x Vertical

OLED SPECIFICATIONS

Characteristics of Display

Display Device	Color OLED display module
Display Mode	Passive matrix
Viewing Area	12.9mm x 9.9mm (horizontal x vertical)
Pixel Format	52RGB x 36 pixels (horizontal x vertical)
Pixel Size	0.21mm x 0.22mm (horizontal x vertical)
Interface	Serial (SPI) interface
Number of Colors	65,536 Colors (16bit: R 5bit/G 6bit/B 5bit) or 256 Colors (8bit: R 2bit/G 3bit/B 3bit)
Operating Temperature Range	-20°C ~ +70°C (-4°F ~ +158°F)
Storage Temperature Range	-30°C ~ +80°C (-22°F ~ +176°F)
Operating Life Time (Display)	15,000 hours (40% pixels ON)

Absolute Maximum Ratings

Items	Symbols	Ratings
Supply Voltage for Logic/Interface	V_{DD}	-0.3V to +4.0V
Supply Voltage for Drive	V_{CC}	0.0V to +19.0V
Input Voltage	V_I	-0.3V to $V_{DD} + 0.3V$

Recommended Operating Conditions

Items	Symbols	Minimum	Typical	Maximum
Supply Voltage for Logic/Interface	V_{DD}	2.4V	2.8V	3.5V
Supply Voltage for Drive	V_{CC}	15.0V	16.0V	17.0V
Input High Level Voltage	V_{IH}	$0.8 \times V_{DD}$	—	—
Input Low Level Voltage	V_{IL}	—	—	$0.2V \times V_{DD}$

Current Consumption

(Temperature at 25°C, $V_{DD} = 2.8V$, $V_{CC} = 16.0V$)

Items	Symbols	Min	Typical	Max
All-Pixels-On Mode *Drive System Power Current	I_{CC1}	—	3.5mA	4.5mA
All-Pixels-On Mode *Logic/IF System Power Current	I_{DD1}	—	0.16mA	0.2mA
Sleep Mode **Drive System Power Current	I_{CC2}	—	—	10 μ A
Sleep Mode **Logic/IF System Power Current	I_{DD2}	—	—	10 μ A

*All pixels shall be turned on with the maximum level gray scale

**All pixels shall be turned off (while chip is operating)

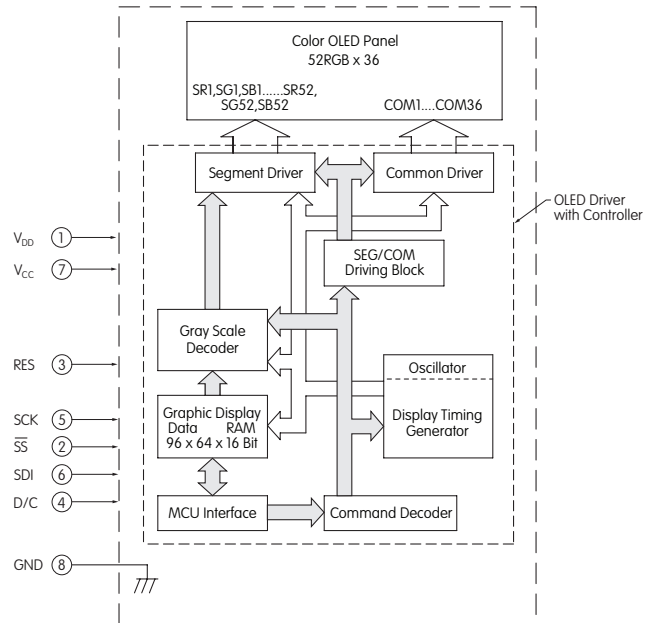
Optical Characteristics (Temperature at 25°C, Initial Value: 87 x 0F)

Items	Min	Typical	Max	Unit	Remarks
Luminosity	75	100	125	cd/m ²	White (All pixels on)
White Color Coordinate	(x)	0.27	0.31	0.35	—
	(y)	0.30	0.35	0.40	—
Red Color Coordinate	(x)	0.60	0.64	0.68	—
	(y)	0.31	0.35	0.39	—
Green Color Coordinate	(x)	0.26	0.30	0.34	—
	(y)	0.59	0.63	0.67	—
Blue Color Coordinate	(x)	0.10	0.14	0.18	—
	(y)	0.12	0.18	0.24	—
Contrast Ratio	100	—	—	—	—

DISPLAY BLOCK DIAGRAM & PIN CONFIGURATIONS

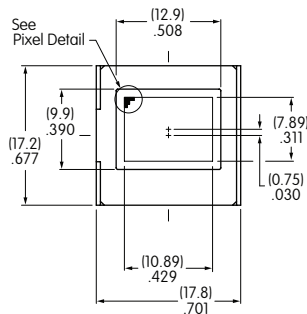


OLED SMARTDISPLAY™

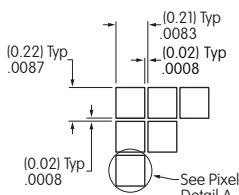


Pin No.	Symbol	Name	Function
①	V _{DD}	Power	Power source for logic circuit
②	SS	Slave Select	Slave select for SPI. This line is active low.
③	RES	Reset	Reset signal input. When pin is low, initialization of chip is executed.
④	D/C	Data/Command	Data/Command Control. When pin is pulled low, data will be interpreted as Command; when pulled high, data will be interpreted as Data.
⑤	SCK	Serial Clock	Clock line for SPI that synchronizes command and data
⑥	SDI	Serial Data In	Data input line for SPI
⑦	V _{CC}	Power	Power source for drive circuit
⑧	GND	Ground	Connect to Ground

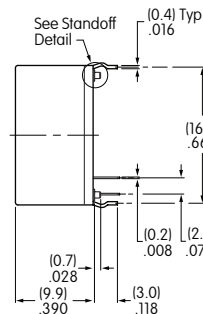
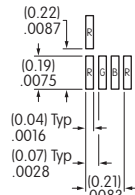
TYPICAL DISPLAY DIMENSIONS



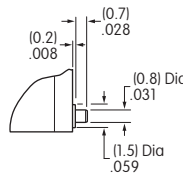
Pixel Detail



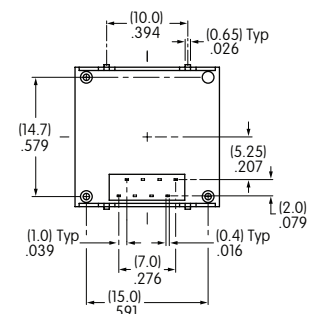
Pixel Detail A



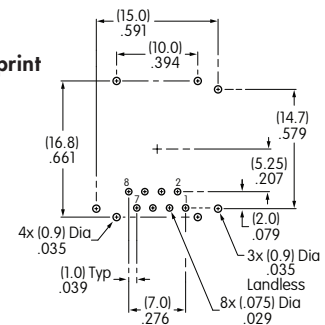
Standoff Detail



Terminal numbers are not on the switch.



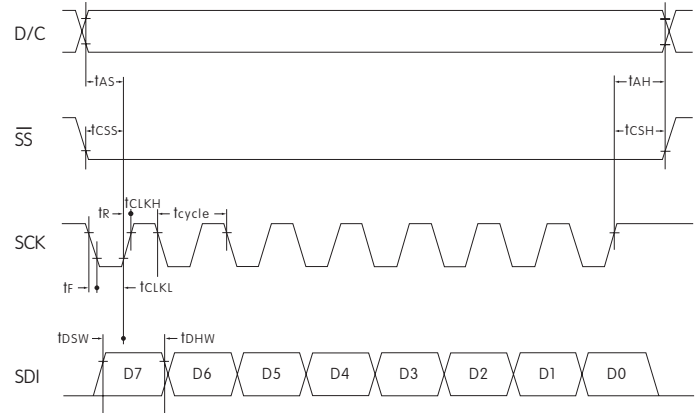
Footprint



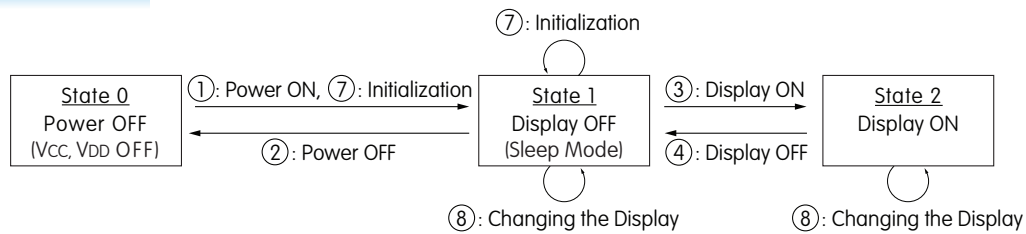
TIMING SPECIFICATIONS

AC Characteristics (Temperature at 25°C), $V_{DD} = 2.4V \sim 3.5V$

Items	Symbols	Minimum	Typical	Maximum
Clock Cycle Time	t_{cycle}	150ns	—	—
D/C Setup Time	t_{AS}	40ns	—	—
D/C Hold Time	t_{AH}	40ns	—	—
\overline{SS} Setup Time	t_{CSS}	75ns	—	—
\overline{SS} Hold Time	t_{CSH}	60ns	—	—
Write Data Setup Time	t_{DSW}	40ns	—	—
Write Data Hold Time	t_{DHW}	40ns	—	—
SCK Low Time	t_{CLKL}	75ns	—	—
SCK High Time	t_{CLKH}	75ns	—	—
SCK Rise Time	t_R	—	—	1.5ns
SCK Fall Time	t_F	—	—	1.5ns



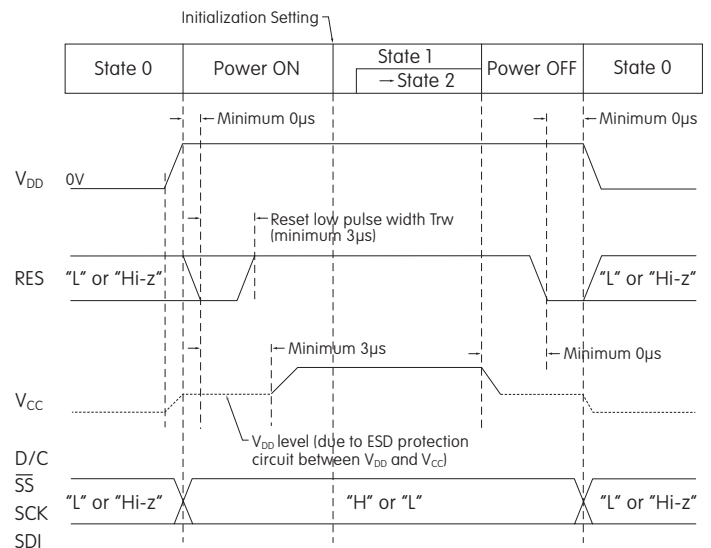
STATE TRANSITION



State Number	State	Display	Sleep	V_{CC}	V_{DD}	Changing the Display
0	Power OFF	OFF	—	OFF	OFF	Disable
1	Display OFF	OFF	ON	ON	ON	Enable
2	Display ON	ON	OFF	ON	ON	Enable

State Transition	Transition	Index
①	Power ON	Refer to "Power ON/OFF Sequence"
②	Power OFF	
③	Display ON	
④	Display OFF	
⑦	Initialization	Initialize Setting of Command/Data
⑧	Image Rewriting	Send Display Data
	Display Settings	Dimmer, Scroll, etc.

Power ON/OFF Sequence



Note: Refer to Application Notes on web site.

PRECAUTIONS FOR HANDLING & STORAGE OF OLED DEVICES



Handling

1. The IS Series OLED devices are electrostatic sensitive. To avoid damage to IC, do not touch terminals unless properly isolated from static electricity.
2. Signal input under conditions not recommended may cause damage to the OLED unit or deterioration of the display. Follow directions regarding supply sequences of power and signal voltages.
3. If the OLED panel is broken, avoid touching the contents. Wash off any contact to the skin or clothing.
4. It is necessary for bracket legs to be Grounded.
5. Recommended soldering time and temperature limits:
11 seconds maximum @ 270°C maximum; avoid temperatures exceeding 80°C at the OLED.
6. The IS series OLED devices are not process sealed.
7. Pixels acquire diminished brightness over time and use, and those most frequently habituated have greater reduction of brightness than those less used. To minimize this difference, operate OLED unit so that all pixels are used as consistently as possible.
8. Avoid contact with any Flux or detergent. If any liquids spill on display surface, immediately wipe with soft absorbent cloth.

Storage

1. Store in original container and away from direct sunlight.
2. Keep away from static electricity.
3. Avoid extreme temperatures, high humidity, gaseous substances, and all forms of chemical contamination.